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(12) **United States Design Patent**
Podubni

(10) **Patent No.:** **US D839,222 S**
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- (54) **MODULAR CIRCUIT BOARD**
- (71) Applicant: **Tiny PCB, Inc.**, San Jose, CA (US)
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- (73) Assignee: **TinyPCB, Inc.**
- (**) Term: **15 Years**
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- (51) **LOC (11) Cl.** **13-03**
- (52) **U.S. Cl.**
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361/761, 807; 439/55, 65, 68, 76.1, 92,
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CPC H05K 3/00; H05K 3/30; H05K 3/301;
H05K 3/34; H05K 3/3405; H05K 3/341;
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H05K 3/40; H05K 7/14; H05K 7/1422;
H05K 7/00; H05K 1/18; H05K 1/02;
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See application file for complete search history.

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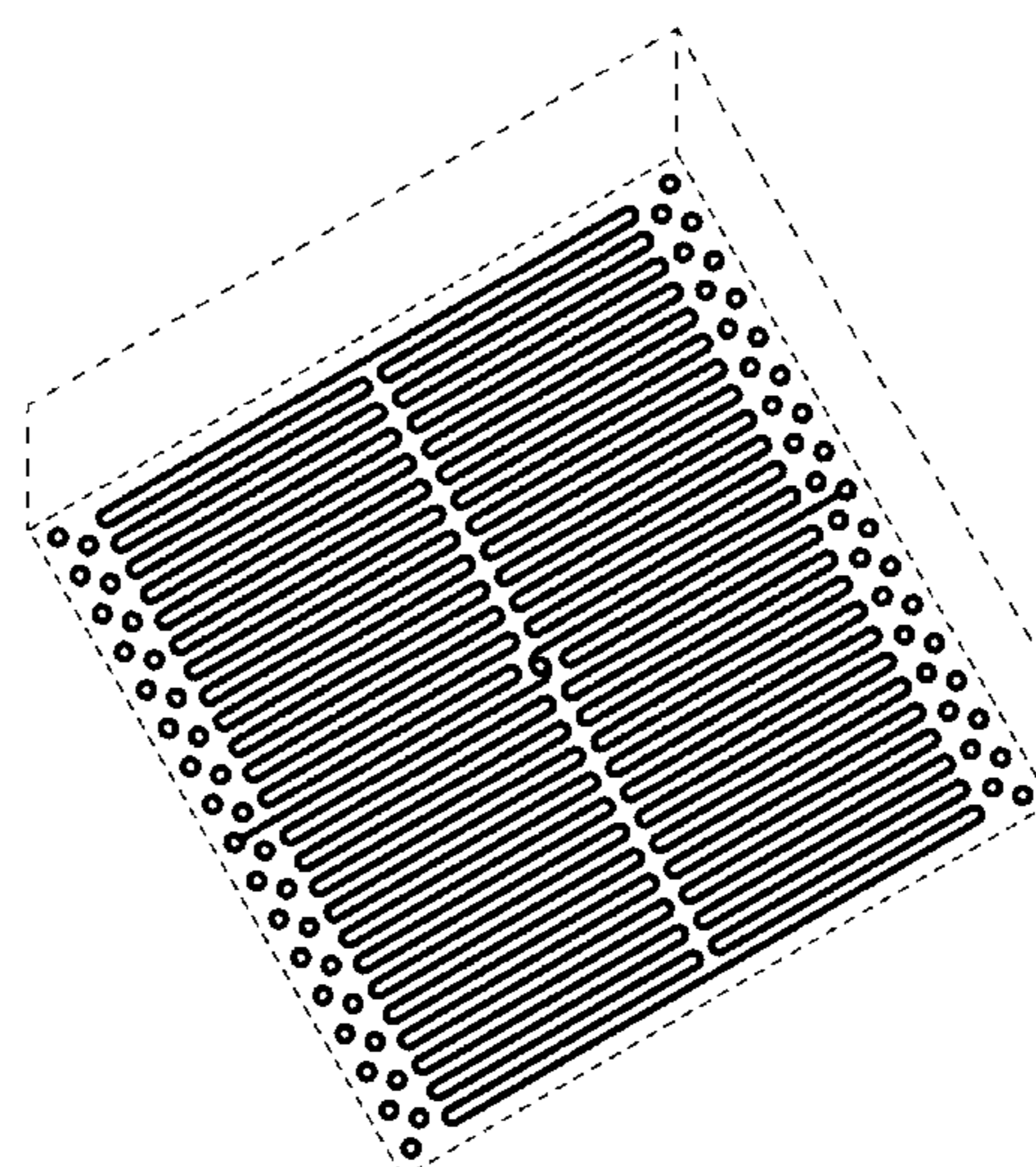
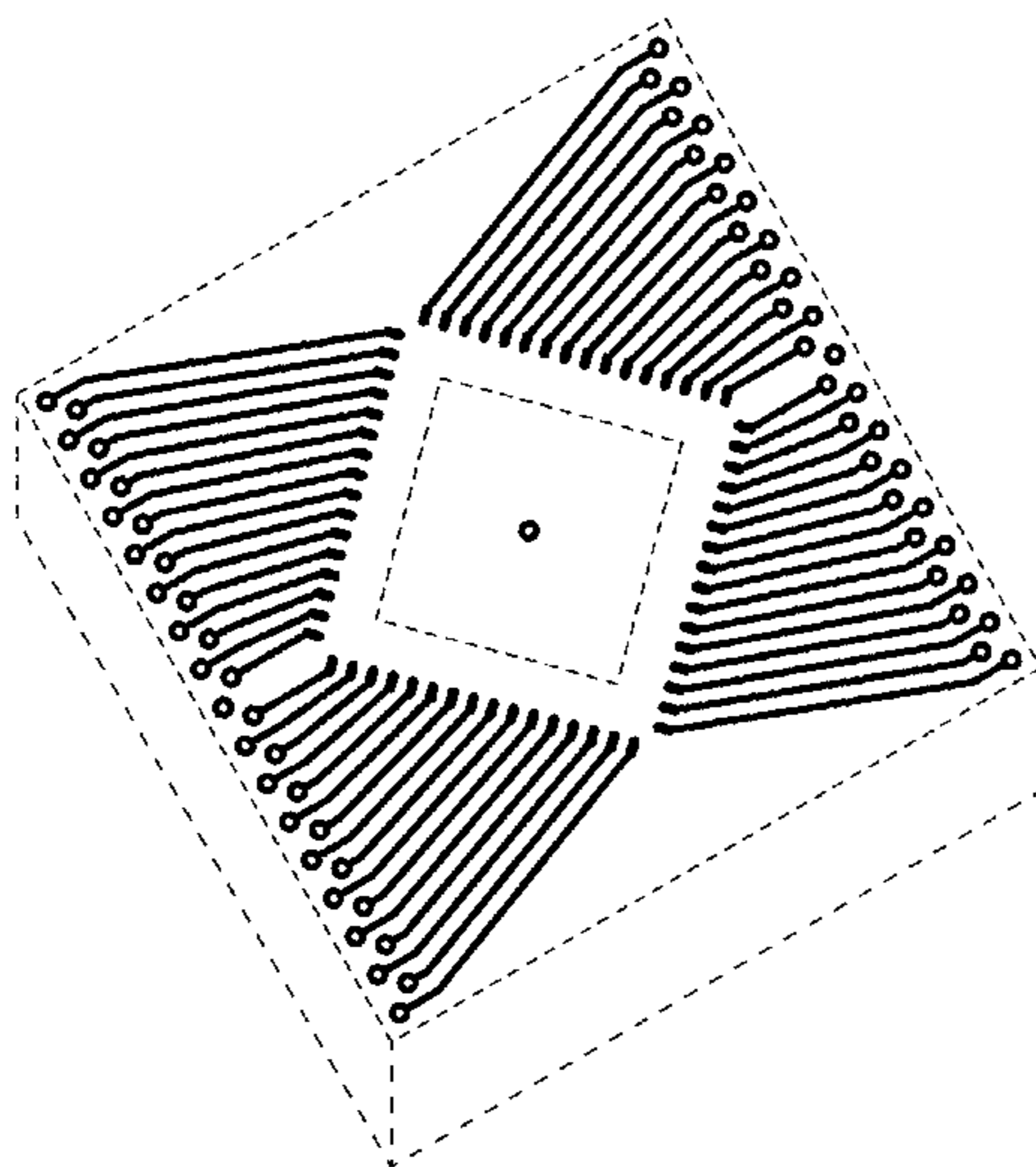
(57) **CLAIM**

The ornamental design for a modular circuit board, as shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of a modular circuit board, showing my new design;
 FIG. 2 is a bottom perspective view thereof;
 FIG. 3 is a top view thereof;
 FIG. 4 is a bottom view thereof; and,
 FIG. 5 is a side view thereof, all other side views being a mirror image thereof.
 The broken lines shown in the drawings represent portions of the modular circuit board that form no part of the claimed design.

1 Claim, 5 Drawing Sheets



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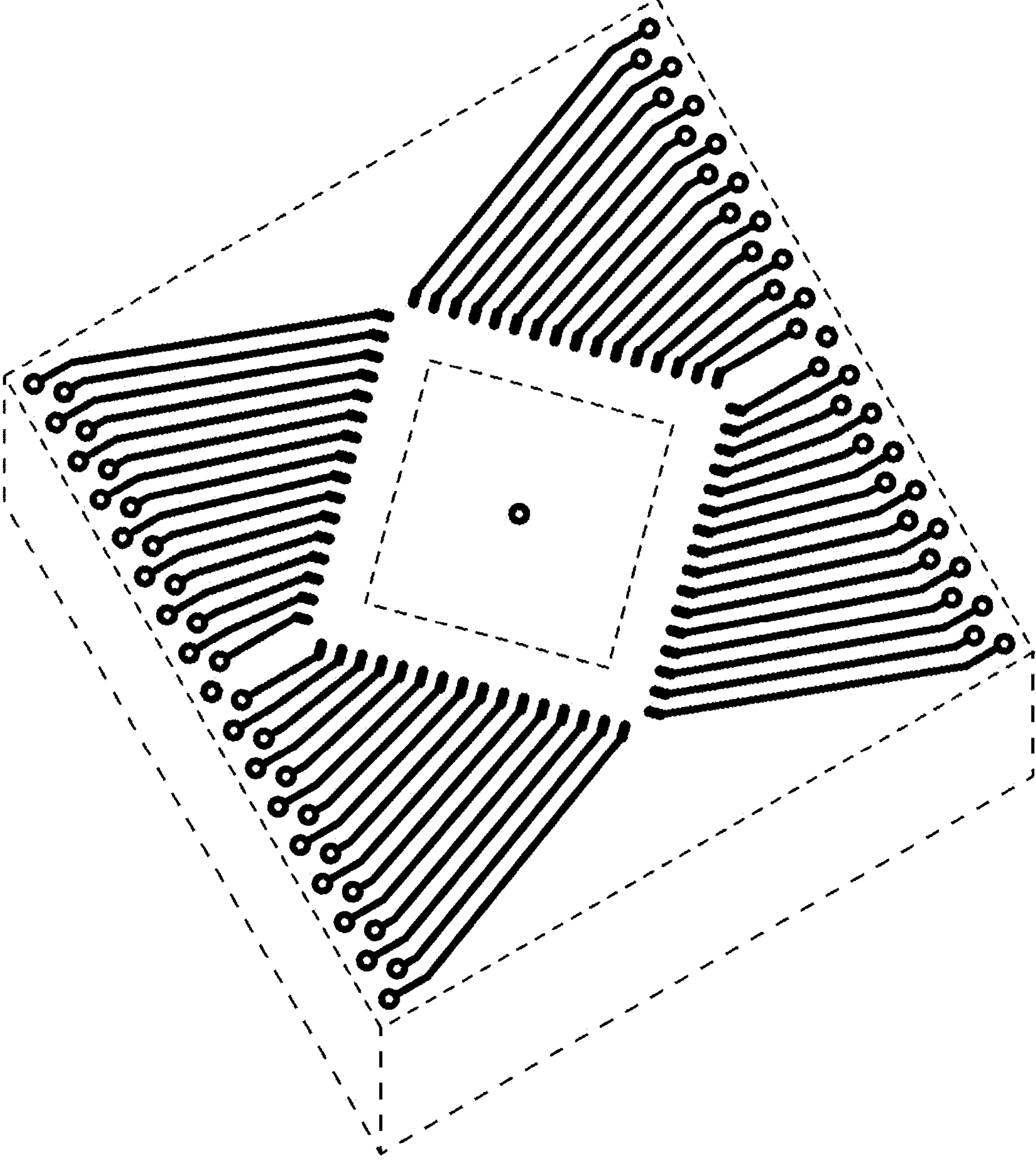


FIG. 1

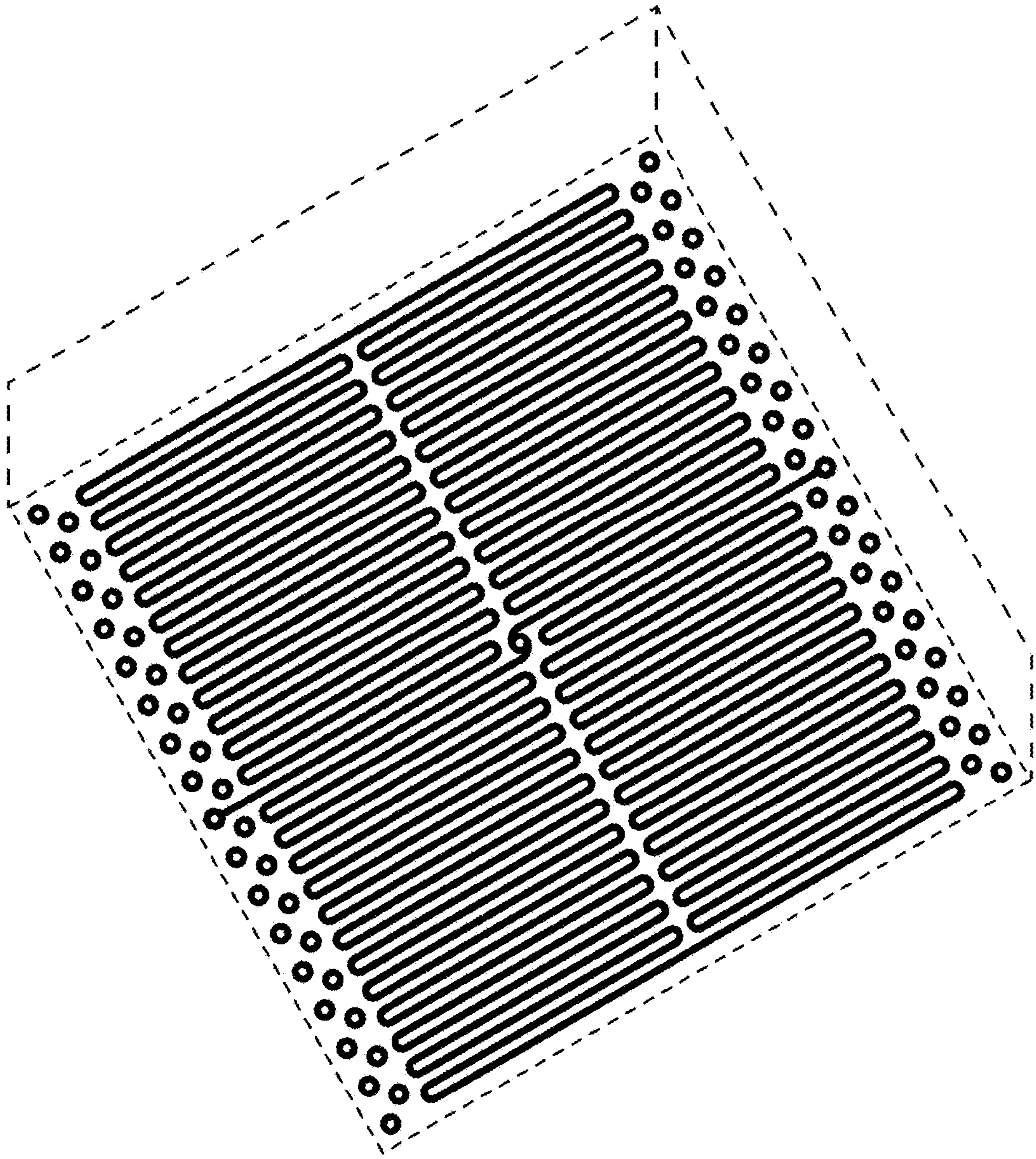


FIG. 2

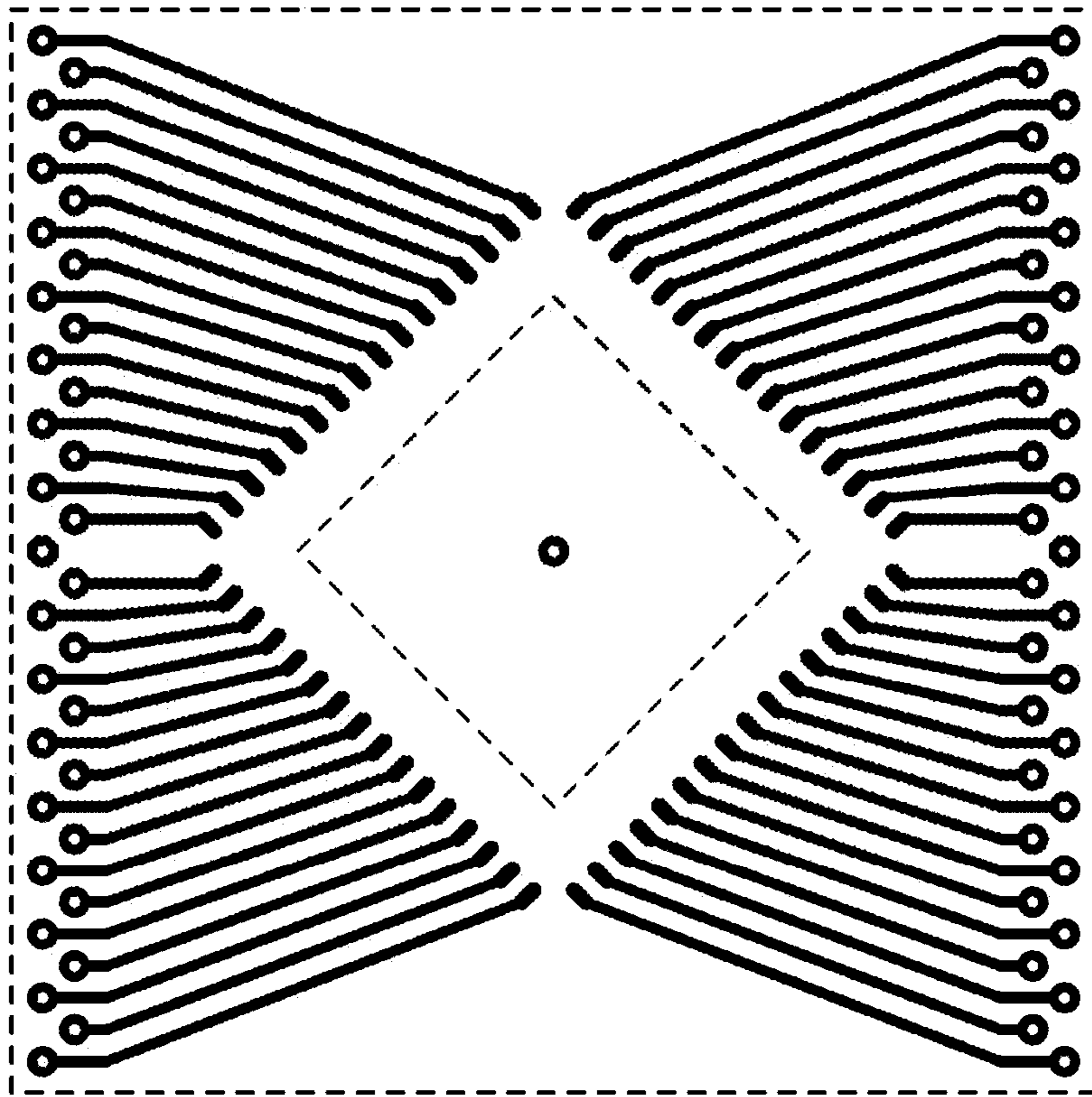


FIG. 3

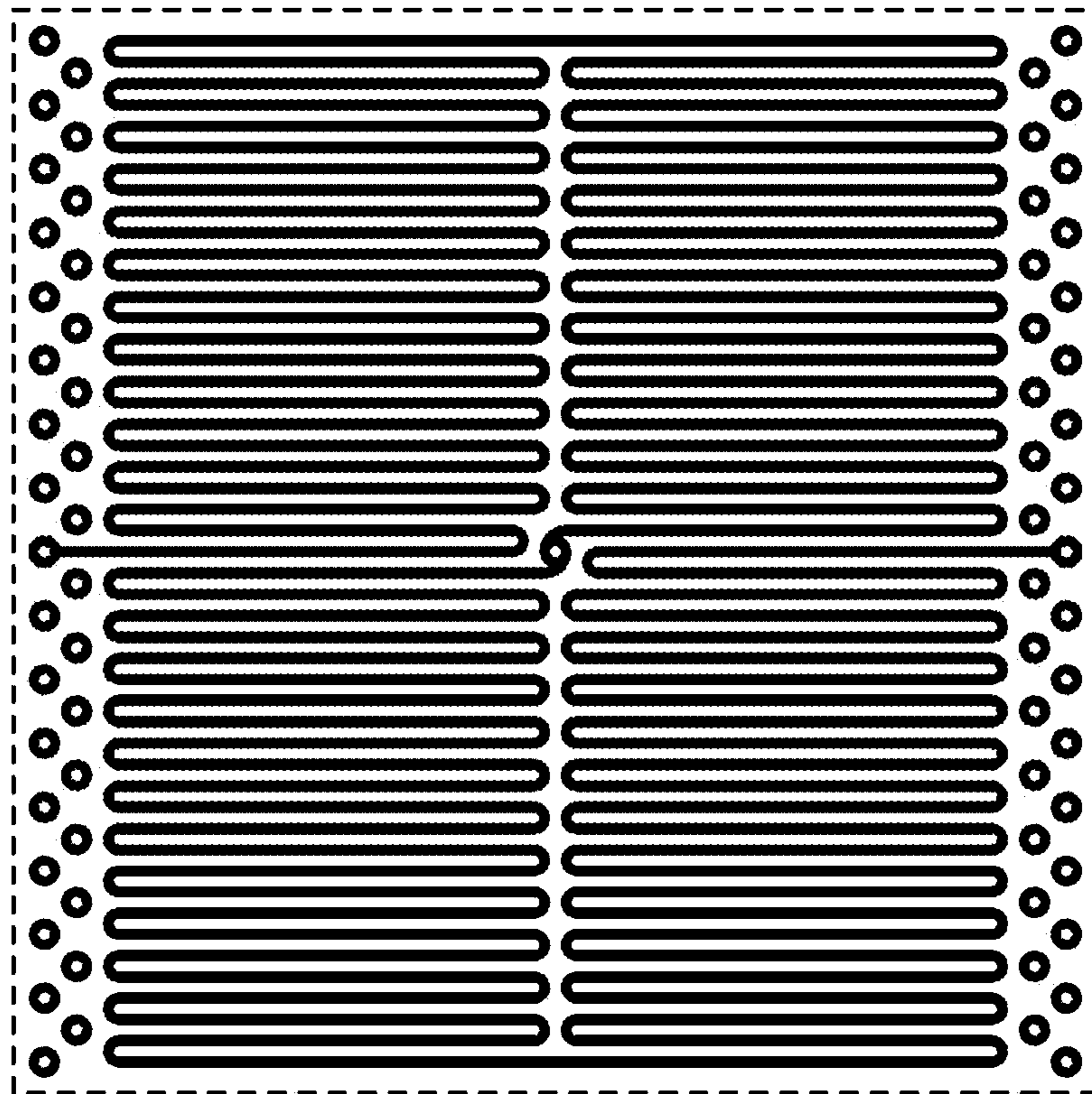


FIG. 4



FIG. 5